U.S. PTO 11/980014 10/29/2007

11-15-2007

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Form **PTO-1595** (Rev. 08/05) OMB No. 0651-0027 (exp. 6/30/2008) U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

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Young Je YUN	Name: Dongbu HiTek Co., Ltd.	
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Additional name(s) of conveying party(ies) attached? Yes N 3. Nature of conveyance/Execution Date(s):	o Street Address: 891-10, Daechi-dong	
Execution Date(s) October 29, 2007	- Gangnam-gu	
Assignment	City: Seoul	
Joint Research Agreement	State:	
Government Interest Assignment Executive Order 9424, Confirmatory License	Country: Republic of Korea Zip: 135-280	
Other	Additional name(s) & address(es) attached? Yes Vo	
A. Patent Application No.(s) Additional numbers	B. Patent No.(s)	
5. Name and address to whom correspondence 6. Total number of applications and patents		
concerning document should be mailed:	involved:1	
Name: Andrew D. Fortney, Ph.D.	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.	
Internal Address: The Law Offices of Andrew D. Fortney, Ph.D., P.		
Street Address: 401 W. Fallbrook Ave., Suite 204	Enclosed None required (government interest not affecting title)	
City: Fresno	8. Payment Information a. Credit Card Last 4 Numbers	
State: CA Zip: 93711	Expiration Date02/09	
Phone Number:559-432-6847	b. Deposit Account Number	
Fax Number: 559-432-6872	Authorized User Name	
Email Address:info@fortneylaw.com	10-29-2007	
9. Signature:	Date	
Signature Andrew D. Fortney, Ph.D.	Total number of pages including cover sheet, attachments, and documents:	
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PATENT REEL: 020123 FRAME: 0322

Attorney Docket No.: [SPO200705-0162US_A2006-S1337US] PATENT

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

Young Je YUN

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

IMAGE SENSOR AND METHOD FOR MANUFACTURING THE SAME

Do hereby sell, assign and transfer to DONGBU HITEK CO., LTD., a corporation of Republic of Korea. having a place of business at 891-10, Dzechi-dong, Gangnam-gu, Seoul ,Korea, 135-280, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries. and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties; Agree that DONGBU HITEK CO., LTD., hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, zeissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned selating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below.

Full Name of Sole/Piest Inventor.	1
Young Je YUN	
1.07	Date: Month/Day/Year
Inventur's Signature	October/29/2407
Junion for	CC 600 /2/1-1

Customer No. 36872

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RECORDED: 10/29/2007